

Welcome to [E-XFL.COM](#)

#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	35
Program Memory Size	24KB (12K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 13x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic18f4458t-i-ml">https://www.e-xfl.com/product-detail/microchip-technology/pic18f4458t-i-ml</a>

---

---

**Note the following details of the code protection feature on Microchip devices:**

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

---

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

#### Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, rfPIC and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Octopus, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, PIC<sup>32</sup> logo, REAL ICE, rfLAB, Select Mode, Total Endurance, TSHARC, UniWinDriver, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2009, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

 Printed on recycled paper.

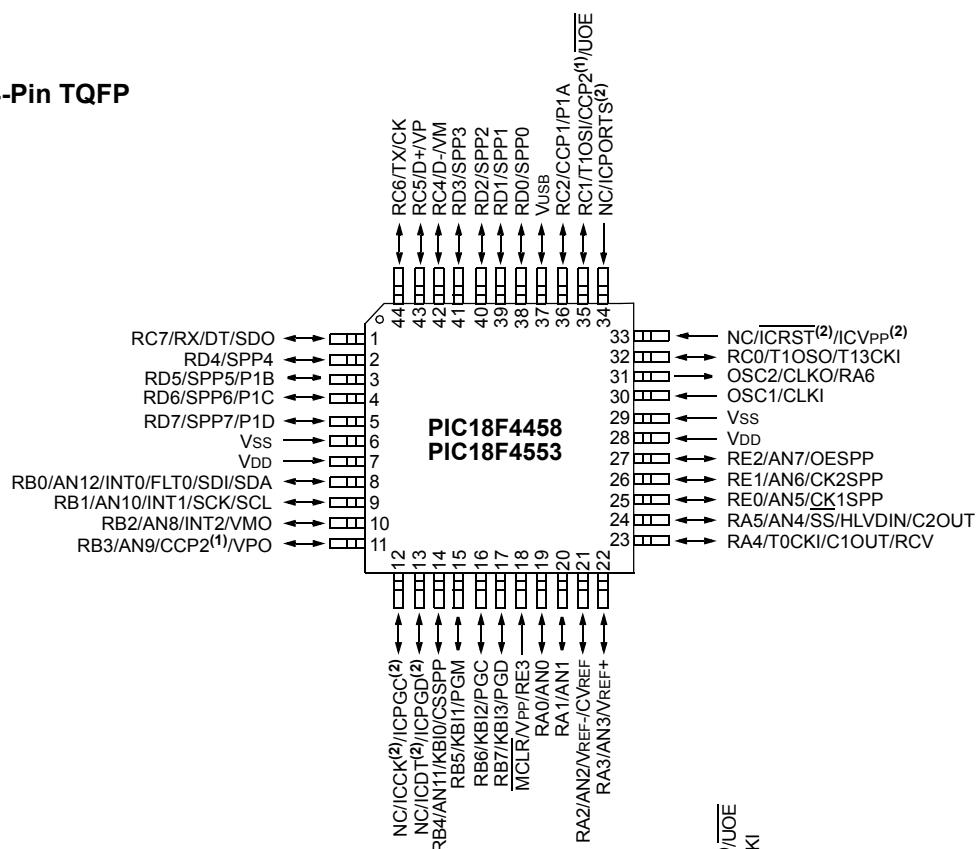
---

**QUALITY MANAGEMENT SYSTEM  
CERTIFIED BY DNV  
= ISO/TS 16949:2002 =**

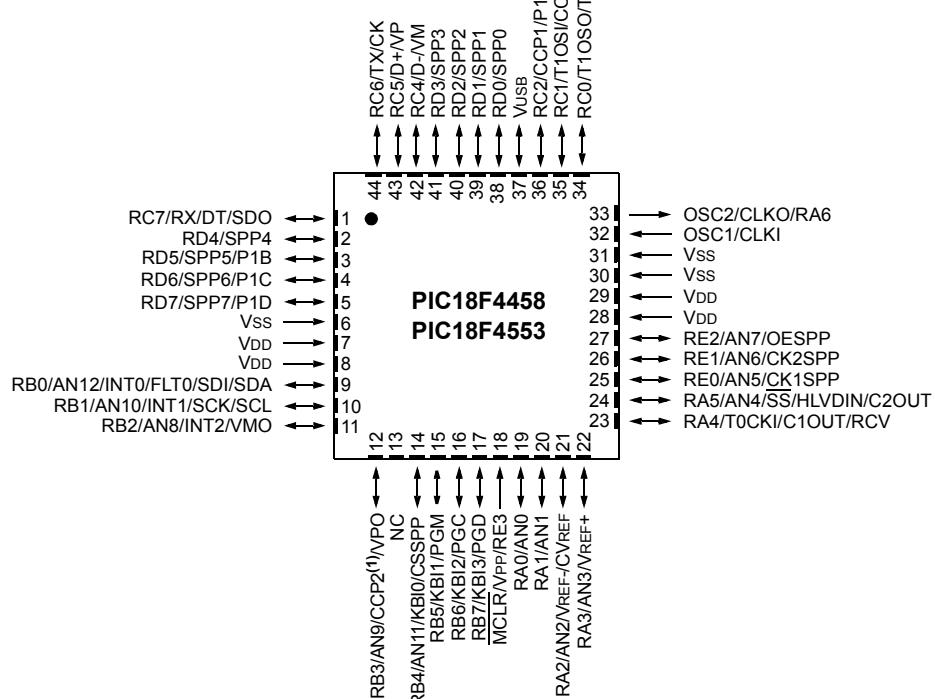
*Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.*

## Pin Diagrams (Continued)

### 44-Pin TQFP



### 44-Pin QFN



**Note 1:** RB3 is the alternate pin for CCP2 multiplexing.

**2:** Special ICPORT features are available only in 44-pin TQFP packages. See **Section 25.9 “Special ICPORT Features”** in the “*PIC18F2455/2550/4455/4550 Data Sheet*”.

# PIC18F2458/2553/4458/4553

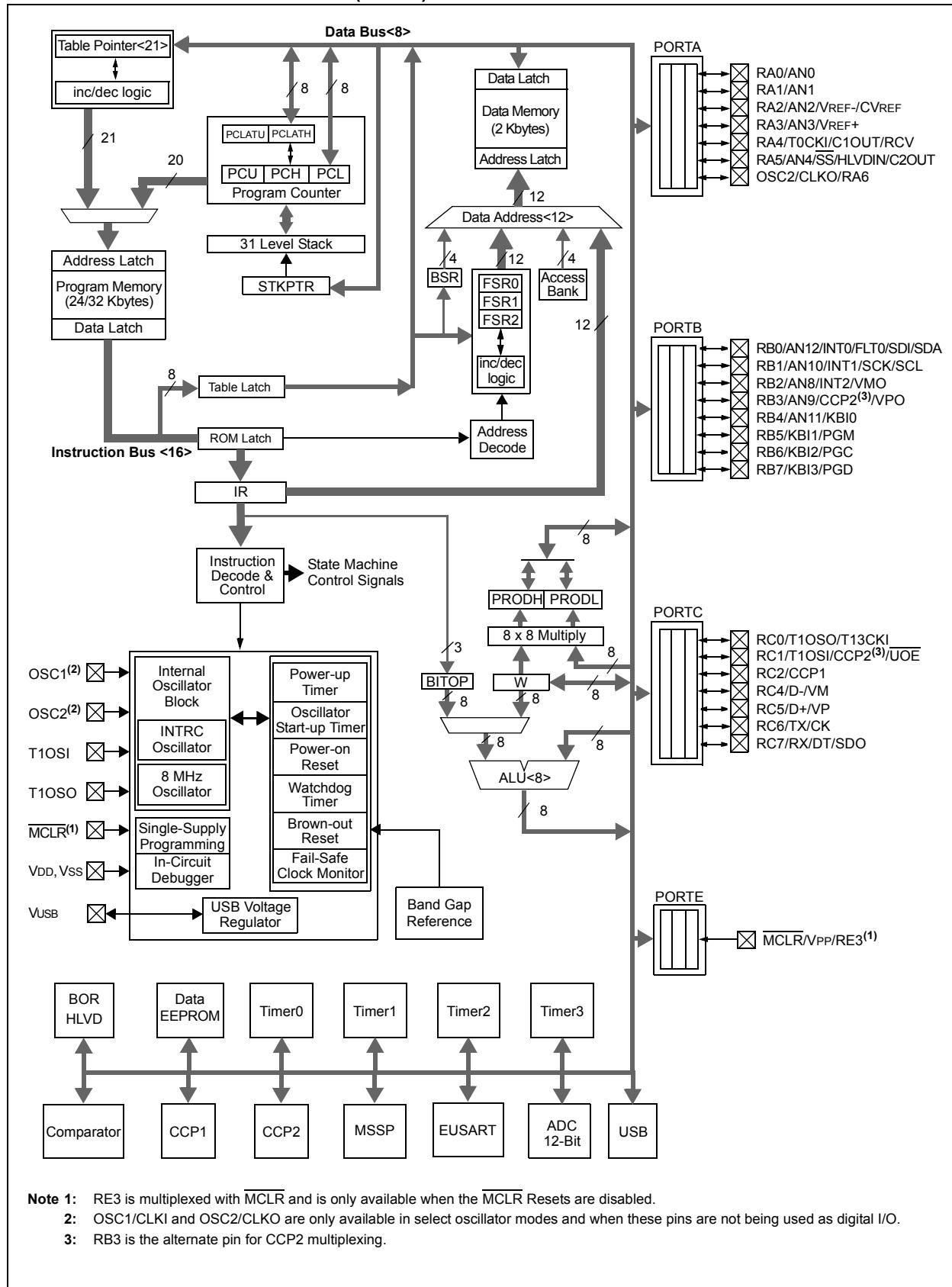
---

**TABLE 1-1: DEVICE FEATURES**

Features	PIC18F2458	PIC18F2553	PIC18F4458	PIC18F4553
Operating Frequency	DC – 48 MHz			
Program Memory (Bytes)	24576	32768	24576	32768
Program Memory (Instructions)	12288	16384	12288	16384
Data Memory (Bytes)	2048	2048	2048	2048
Data EEPROM Memory (Bytes)	256	256	256	256
Interrupt Sources	19	19	20	20
I/O Ports	Ports A, B, C, (E)	Ports A, B, C, (E)	Ports A, B, C, D, E	Ports A, B, C, D, E
Timers	4	4	4	4
Capture/Compare/PWM Modules	2	2	1	1
Enhanced Capture/Compare/PWM Modules	0	0	1	1
Serial Communications	MSSP, Enhanced USART	MSSP, Enhanced USART	MSSP, Enhanced USART	MSSP, Enhanced USART
Universal Serial Bus (USB) Module	1	1	1	1
Streaming Parallel Port (SPP)	No	No	Yes	Yes
12-Bit Analog-to-Digital Converter Module	10 Input Channels	10 Input Channels	13 Input Channels	13 Input Channels
Comparators	2	2	2	2
Resets (and Delays)	POR, BOR, WDT, RESET Instruction, Stack Full, Stack Underflow, MCLR (optional), (PWRT, OST)	POR, BOR, WDT, RESET Instruction, Stack Full, Stack Underflow, MCLR (optional), (PWRT, OST)	POR, BOR, WDT, RESET Instruction, Stack Full, Stack Underflow, MCLR (optional), (PWRT, OST)	POR, BOR, WDT, RESET Instruction, Stack Full, Stack Underflow, MCLR (optional), (PWRT, OST)
Programmable High/Low-Voltage Detect	Yes	Yes	Yes	Yes
Programmable Brown-out Reset	Yes	Yes	Yes	Yes
Instruction Set	75 Instructions; 83 with Extended Instruction Set Enabled			
Packages	28-Pin SPDIP 28-Pin SOIC	28-Pin SPDIP 28-Pin SOIC	40-Pin PDIP 44-Pin QFN 44-Pin TQFP	40-Pin PDIP 44-Pin QFN 44-Pin TQFP
Corresponding Devices with 10-Bit A/D	PIC18F2455	PIC18F2550	PIC18F4455	PIC18F4550

# PIC18F2458/2553/4458/4553

**FIGURE 1-1: PIC18F2458/2553 (28-PIN) BLOCK DIAGRAM**



# PIC18F2458/2553/4458/4553

---

**TABLE 1-2: PIC18F2458/2553 PINOUT I/O DESCRIPTIONS (CONTINUED)**

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	SPDIP, SOIC			
RA0/AN0 RA0 AN0	2	I/O I	TTL Analog	PORTA is a bidirectional I/O port.  Digital I/O. Analog input 0.
RA1/AN1 RA1 AN1	3	I/O I	TTL Analog	Digital I/O.  Analog input 1.
RA2/AN2/VREF-/CVREF RA2 AN2 VREF- CVREF	4	I/O I I O	TTL Analog Analog Analog	Digital I/O.  Analog input 2. A/D reference voltage (low) input. Analog comparator reference output.
RA3/AN3/VREF+ RA3 AN3 VREF+	5	I/O I I	TTL Analog Analog	Digital I/O.  Analog input 3. A/D reference voltage (high) input.
RA4/T0CKI/C1OUT/RCV RA4 T0CKI C1OUT RCV	6	I/O I O I	ST ST — TTL	Digital I/O.  Timer0 external clock input. Comparator 1 output. External USB transceiver RCV input.
RA5/AN4/SS/ HLVDIN/C2OUT RA5 AN4 SS HLVDIN C2OUT	7	I/O I I I O	TTL Analog TTL Analog —	Digital I/O.  Analog input 4. SPI slave select input. High/Low-Voltage Detect input. Comparator 2 output.
RA6	—	—	—	See the OSC2/CLKO/RA6 pin.

**Legend:** TTL = TTL compatible input      CMOS = CMOS compatible input or output  
 ST = Schmitt Trigger input with CMOS levels      I = Input  
 O = Output      P = Power

**Note 1:** Alternate assignment for CCP2 when CCP2MX Configuration bit is cleared.

**2:** Default assignment for CCP2 when CCP2MX Configuration bit is set.

# PIC18F2458/2553/4458/4553

TABLE 1-2: PIC18F2458/2553 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	SPDIP, SOIC			
RB0/AN12/INT0/FLT0/ SDI/SDA	21			PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0 AN12 INT0 FLT0 SDI SDA		I/O         I/O	TTL Analog ST ST ST ST	Digital I/O. Analog input 12. External interrupt 0. PWM Fault input (CCP1 module). SPI data in. I <sup>2</sup> C™ data I/O.
RB1/AN10/INT1/SCK/ SCL	22			
RB1 AN10 INT1 SCK SCL		I/O     I/O I/O	TTL Analog ST ST ST	Digital I/O. Analog input 10. External interrupt 1. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I <sup>2</sup> C mode.
RB2/AN8/INT2/VMO	23			
RB2 AN8 INT2 VMO		I/O     O	TTL Analog ST —	Digital I/O. Analog input 8. External interrupt 2. External USB transceiver VMO output.
RB3/AN9/CCP2/VPO	24			
RB3 AN9 CCP2 <sup>(1)</sup> VPO		I/O   I/O O	TTL Analog ST —	Digital I/O. Analog input 9. Capture 2 input/Compare 2 output/PWM 2 output. External USB transceiver VPO output.
RB4/AN11/KBI0	25			
RB4 AN11 KBI0		I/O   	TTL Analog TTL	Digital I/O. Analog input 11. Interrupt-on-change pin.
RB5/KBI1/PGM	26			
RB5 KBI1 PGM		I/O   I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. Low-Voltage ICSP™ Programming enable pin.
RB6/KBI2/PGC	27			
RB6 KBI2 PGC		I/O   I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming clock pin.
RB7/KBI3/PGD	28			
RB7 KBI3 PGD		I/O   I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming data pin.

**Legend:** TTL = TTL compatible input CMOS = CMOS compatible input or output  
 ST = Schmitt Trigger input with CMOS levels | = Input  
 O = Output P = Power

**Note 1:** Alternate assignment for CCP2 when CCP2MX Configuration bit is cleared.

**2:** Default assignment for CCP2 when CCP2MX Configuration bit is set.

# PIC18F2458/2553/4458/4553

TABLE 1-2: PIC18F2458/2553 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	SPDIP, SOIC			
RC0/T1OSO/T13CKI RC0 T1OSO T13CKI	11	I/O O I	ST — ST	PORTC is a bidirectional I/O port.  Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2/UOE RC1 T1OSI CCP2 <sup>(2)</sup> UOE	12	I/O I I/O —	ST CMOS ST —	Digital I/O. Timer1 oscillator input. Capture 2 input/Compare 2 output/PWM2 output. External USB transceiver OE output.
RC2/CCP1 RC2 CCP1	13	I/O I/O	ST ST	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output.
RC4/D-/VM RC4 D- VM	15	I I/O I	TTL — TTL	Digital input. USB differential minus line (input/output). External USB transceiver VM input.
RC5/D+/VP RC5 D+ VP	16	I I/O O	TTL — TTL	Digital input. USB differential plus line (input/output). External USB transceiver VP input.
RC6/TX/CK RC6 TX CK	17	I/O O I/O	ST — ST	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see RX/DT).
RC7/RX/DT/SDO RC7 RX DT SDO	18	I/O I I/O O	ST ST ST —	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see TX/CK). SPI data out.
RE3	—	—	—	See MCLR/VPP/RE3 pin.
VUSB	14	O P	— —	Internal USB transceiver power supply. When the internal USB regulator is enabled, VUSB is the regulator output. When the internal USB regulator is disabled, VUSB is the power input for the USB transceiver.
VSS	8, 19	P	—	Ground reference for logic and I/O pins.
VDD	20	P	—	Positive supply for logic and I/O pins.

**Legend:** TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

P = Power

**Note 1:** Alternate assignment for CCP2 when CCP2MX Configuration bit is cleared.

**2:** Default assignment for CCP2 when CCP2MX Configuration bit is set.

# PIC18F2458/2553/4458/4553

---

**TABLE 1-3: PIC18F4458/4553 PINOUT I/O DESCRIPTIONS**

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
MCLR/VPP/RE3 MCLR  VPP RE3	1	18	18	I  P I	ST  ST	Master Clear (input) or programming voltage (input). Master Clear (Reset) input. This pin is an active-low Reset to the device. Programming voltage input. Digital input.
OSC1/CLKI OSC1 CLKI	13	32	30	I I	Analog Analog	Oscillator crystal or external clock input. Oscillator crystal input or external clock source input. External clock source input. Always associated with pin function OSC1. (See OSC2/CLKO pin.)
OSC2/CLKO/RA6 OSC2  CLKO  RA6	14	33	31	O  O	— —	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKO which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate. General purpose I/O pin.

**Legend:** TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

P = Power

**Note 1:** Alternate assignment for CCP2 when CCP2MX Configuration bit is cleared.

**2:** Default assignment for CCP2 when CCP2MX Configuration bit is set.

**3:** These pins are No Connect unless the ICPRT Configuration bit is set. For NC/ICPORTS, the pin is No Connect unless ICPRT is set and the DEBUG Configuration bit is cleared.

# PIC18F2458/2553/4458/4553

---

TABLE 1-3: PIC18F4458/4553 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
RA0/AN0 RA0 AN0	2	19	19	I/O I	TTL Analog	PORTA is a bidirectional I/O port.  Digital I/O. Analog input 0.
RA1/AN1 RA1 AN1	3	20	20	I/O I	TTL Analog	Digital I/O.  Analog input 1.
RA2/AN2/VREF-/CVREF RA2 AN2 VREF- CVREF	4	21	21	I/O I I O	TTL Analog Analog Analog	Digital I/O.  Analog input 2. A/D reference voltage (low) input. Analog comparator reference output.
RA3/AN3/VREF+ RA3 AN3 VREF+	5	22	22	I/O I I	TTL Analog Analog	Digital I/O.  Analog input 3. A/D reference voltage (high) input.
RA4/T0CKI/C1OUT/RCV RA4 T0CKI C1OUT RCV	6	23	23	I/O I O I	ST ST — TTL	Digital I/O.  Timer0 external clock input. Comparator 1 output. External USB transceiver RCV input.
RA5/AN4/SS/ HLVDIN/C2OUT RA5 AN4 SS HLVDIN C2OUT	7	24	24	I/O I I I O	TTL Analog TTL Analog —	Digital I/O.  Analog input 4. SPI slave select input. High/Low-Voltage Detect input. Comparator 2 output.
RA6	—	—	—	—	—	See the OSC2/CLKO/RA6 pin.

**Legend:** TTL = TTL compatible input

ST = Schmitt Trigger input with CMOS levels

O = Output

CMOS = CMOS compatible input or output

I = Input

P = Power

**Note 1:** Alternate assignment for CCP2 when CCP2MX Configuration bit is cleared.

**2:** Default assignment for CCP2 when CCP2MX Configuration bit is set.

**3:** These pins are No Connect unless the ICPRT Configuration bit is set. For NC/ICPORTS, the pin is No Connect unless ICPRT is set and the DEBUG Configuration bit is cleared.

# PIC18F2458/2553/4458/4553

TABLE 1-3: PIC18F4458/4553 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
RB0/AN12/INT0/ FLT0/SDI/SDA	33	9	8	I/O	TTL	PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0				I	Analog	Digital I/O.
AN12				I		Analog input 12.
INT0				I	ST	External interrupt 0.
FLT0				I	ST	Enhanced PWM Fault input (ECCP1 module).
SDI				I	ST	SPI data in.
SDA				I/O	ST	I <sup>2</sup> C™ data I/O.
RB1/AN10/INT1/SCK/ SCL	34	10	9	I/O	TTL	Digital I/O.
RB1				I	Analog	Analog input 10.
AN10				I		External interrupt 1.
INT1				I	ST	Synchronous serial clock input/output for SPI mode.
SCK				I/O	ST	Synchronous serial clock input/output for I <sup>2</sup> C mode.
SCL				I/O	ST	
RB2/AN8/INT2/VMO	35	11	10	I/O	TTL	Digital I/O.
RB2				I	Analog	Analog input 8.
AN8				I		External interrupt 2.
INT2				O	—	External USB transceiver VMO output.
RB3/AN9/CCP2/VPO	36	12	11	I/O	TTL	Digital I/O.
RB3				I	Analog	Analog input 9.
AN9				I/O	ST	Capture 2 input/Compare 2 output/PWM 2 output.
CCP2 <sup>(1)</sup>				O	—	External USB transceiver VPO output.
VPO						
RB4/AN11/KBI0/CSSPP	37	14	14	I/O	TTL	Digital I/O.
RB4				I	Analog	Analog input 11.
AN11				I	TTL	Interrupt-on-change pin.
KBI0				O	—	SPP chip select control output.
CSSPP						
RB5/KBI1/PGM	38	15	15	I/O	TTL	Digital I/O.
RB5				I	TTL	Interrupt-on-change pin.
KBI1				I/O	ST	Low-Voltage ICSP™ Programming enable pin.
PGM						
RB6/KBI2/PGC	39	16	16	I/O	TTL	Digital I/O.
RB6				I	TTL	Interrupt-on-change pin.
KBI2				I/O	ST	In-Circuit Debugger and ICSP programming clock pin.
PGC						
RB7/KBI3/PGD	40	17	17	I/O	TTL	Digital I/O.
RB7				I	TTL	Interrupt-on-change pin.
KBI3				I/O	ST	In-Circuit Debugger and ICSP programming data pin.
PGD						

**Legend:** TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

P = Power

**Note 1:** Alternate assignment for CCP2 when CCP2MX Configuration bit is cleared.

**2:** Default assignment for CCP2 when CCP2MX Configuration bit is set.

**3:** These pins are No Connect unless the ICPRT Configuration bit is set. For NC/ICPORTS, the pin is No Connect unless ICPRT is set and the DEBUG Configuration bit is cleared.

# PIC18F2458/2553/4458/4553

TABLE 1-3: PIC18F4458/4553 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
						PORTD is a bidirectional I/O port or a Streaming Parallel Port (SPP). PORTD can be software programmed for internal weak pull-ups on all inputs. These pins have TTL input buffers when the SPP module is enabled.
RD0/SPP0 RD0 SPP0	19	38	38	I/O I/O	ST TTL	Digital I/O. Streaming Parallel Port data.
RD1/SPP1 RD1 SPP1	20	39	39	I/O I/O	ST TTL	Digital I/O. Streaming Parallel Port data.
RD2/SPP2 RD2 SPP2	21	40	40	I/O I/O	ST TTL	Digital I/O. Streaming Parallel Port data.
RD3/SPP3 RD3 SPP3	22	41	41	I/O I/O	ST TTL	Digital I/O. Streaming Parallel Port data.
RD4/SPP4 RD4 SPP4	27	2	2	I/O I/O	ST TTL	Digital I/O. Streaming Parallel Port data.
RD5/SPP5/P1B RD5 SPP5 P1B	28	3	3	I/O I/O O	ST TTL —	Digital I/O. Streaming Parallel Port data. ECCP1 PWM output, channel B.
RD6/SPP6/P1C RD6 SPP6 P1C	29	4	4	I/O I/O O	ST TTL —	Digital I/O. Streaming Parallel Port data. ECCP1 PWM output, channel C.
RD7/SPP7/P1D RD7 SPP7 P1D	30	5	5	I/O I/O O	ST TTL —	Digital I/O. Streaming Parallel Port data. ECCP1 PWM output, channel D.

**Legend:** TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

P = Power

**Note 1:** Alternate assignment for CCP2 when CCP2MX Configuration bit is cleared.

**2:** Default assignment for CCP2 when CCP2MX Configuration bit is set.

**3:** These pins are No Connect unless the ICPRT Configuration bit is set. For NC/ICPORTS, the pin is No Connect unless ICPRT is set and the DEBUG Configuration bit is cleared.

The value in the ADRESH:ADRESL registers is unknown following Power-on and Brown-out Resets, and is not affected by any other Reset.

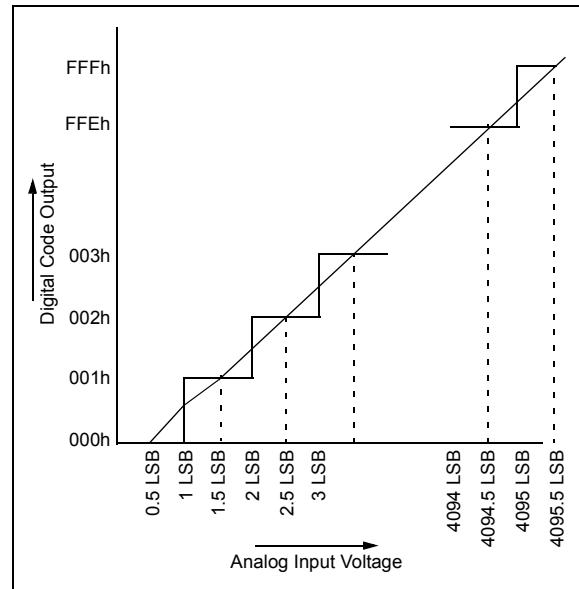
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see **Section 2.1 “A/D Acquisition Requirements”**. After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/DONE bit and the actual start of the conversion.

The following steps should be followed to perform an A/D conversion:

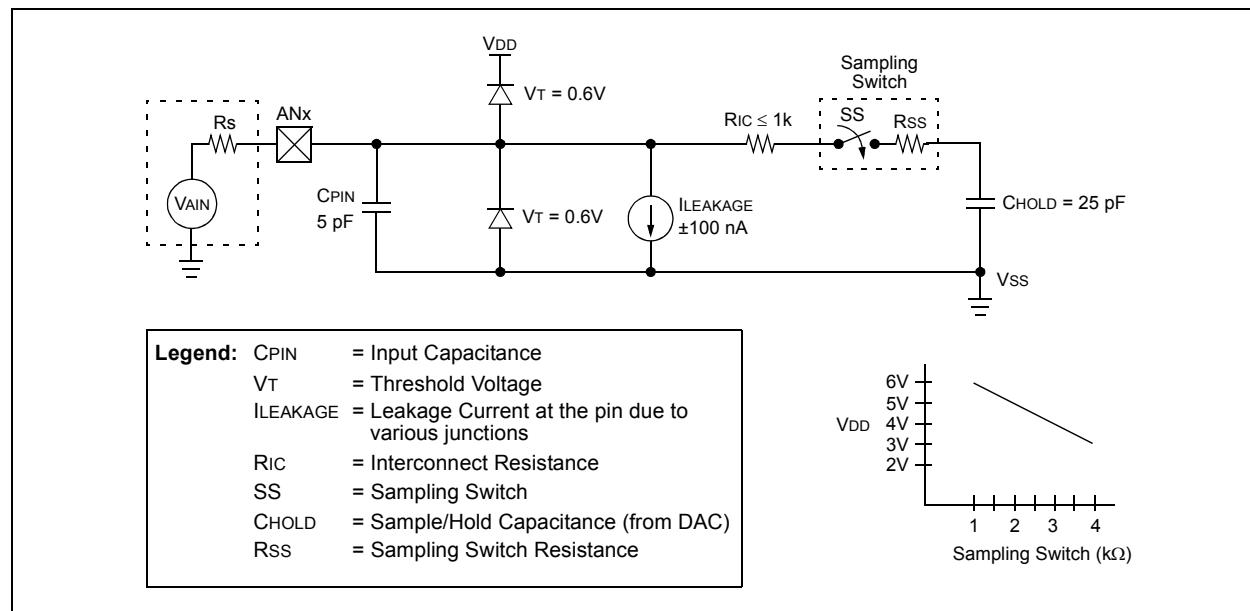
1. Configure the A/D module:
  - Configure analog pins, voltage reference and digital I/O (ADCON1)
  - Select A/D input channel (ADCON0)
  - Select A/D acquisition time (ADCON2)
  - Select A/D conversion clock (ADCON2)
  - Turn on A/D module (ADCON0)
2. Configure A/D interrupt (if desired):
  - Clear ADIF bit
  - Set ADIE bit
  - Set GIE bit
3. Wait the required acquisition time (if required).
4. Start conversion:
  - Set GO/DONE bit (ADCON0 register)

5. Wait for A/D conversion to complete, by either:
  - Polling for the GO/DONE bit to be cleared
  - OR
  - Waiting for the A/D interrupt
6. Read A/D Result registers (ADRESH:ADRESL); clear bit ADIF, if required.
7. For next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before the next acquisition starts.

**FIGURE 2-2: A/D TRANSFER FUNCTION**



**FIGURE 2-3: ANALOG INPUT MODEL**



# PIC18F2458/2553/4458/4553

## 2.1 A/D Acquisition Requirements

For the A/D Converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 2-3. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (Rss) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). **The maximum recommended impedance for analog sources is 2.5 kΩ.** After the analog input channel is selected (changed), the channel must be sampled for at least the minimum acquisition time before starting a conversion.

**Note:** When the conversion is started, the holding capacitor is disconnected from the input pin.

To calculate the minimum acquisition time, Equation 2-1 may be used. This equation assumes that 1/2 LSB error is used (4096 steps for the 12-bit A/D). The 1/2 LSB error is the maximum error allowed for the A/D to meet its specified resolution.

Example 2-3 shows the calculation of the minimum required acquisition time, TACQ. This calculation is based on the following application system assumptions:

CHOLD	=	25 pF
Rs	=	2.5 kΩ
Conversion Error	≤	1/2 LSB
VDD	=	3V → Rss = 4 kΩ
Temperature	=	85°C (system max.)

## EQUATION 2-1: ACQUISITION TIME

$$\begin{aligned} T_{ACQ} &= \text{Amplifier Settling Time} + \text{Holding Capacitor Charging Time} + \text{Temperature Coefficient} \\ &= T_{AMP} + T_C + T_{COFF} \end{aligned}$$

## EQUATION 2-2: A/D MINIMUM CHARGING TIME

$$\begin{aligned} V_{HOLD} &= (V_{REF} - (V_{REF}/4096)) \cdot (1 - e^{(-T_C/CHOLD(RIC + RSS + RS))}) \\ \text{or} \\ T_C &= -(CHOLD)(RIC + RSS + RS) \ln(1/4096) \end{aligned}$$

## EQUATION 2-3: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

$$\begin{aligned} T_{ACQ} &= T_{AMP} + T_C + T_{COFF} \\ T_{AMP} &= 0.2 \mu s \\ T_{COFF} &= (Temp - 25^\circ C)(0.02 \mu s/\text{ }^\circ C) \\ &\quad (85^\circ C - 25^\circ C)(0.02 \mu s/\text{ }^\circ C) \\ &\quad 1.2 \mu s \\ \text{Temperature coefficient is only required for temperatures } > 25^\circ C. \text{ Below } 25^\circ C, T_{COFF} = 0 \mu s. \\ T_C &= -(CHOLD)(RIC + RSS + RS) \ln(1/4096) \mu s \\ &\quad -(25 \text{ pF})(1 \text{ k}\Omega + 4 \text{ k}\Omega + 2.5 \text{ k}\Omega) \ln(0.0002441) \mu s \\ &\quad 1.56 \mu s \\ T_{ACQ} &= 0.2 \mu s + 1.56 \mu s + 1.2 \mu s \\ &= 2.96 \mu s \end{aligned}$$

## 2.2 Selecting and Configuring Acquisition Time

The ADCON2 register allows the user to select an acquisition time that occurs each time the GO/DONE bit is set. It also gives users the option to use an automatically determined acquisition time.

Acquisition time may be set with the ACQT2:ACQT0 bits (ADCON2<5:3>), which provides a range of 2 to 20 TAD. When the GO/DONE bit is set, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there may be no need to wait for an acquisition time between selecting a channel and setting the GO/DONE bit.

Manual acquisition is selected when ACQT2:ACQT0 = 000. When the GO/DONE bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and setting the GO/DONE bit. This option is also the default Reset state of the ACQT2:ACQT0 bits and is compatible with devices that do not offer programmable acquisition times.

In either case, when the conversion is completed, the GO/DONE bit is cleared, the ADIF flag is set and the A/D begins sampling the currently selected channel again. If an acquisition time is programmed, there is nothing to indicate if the acquisition time has ended or if the conversion has begun.

**TABLE 2-1: TAD vs. DEVICE OPERATING FREQUENCIES**

A/D Clock Source (TAD)	ADCS2:ADCS0	Assumes TAD Min. = 0.8 $\mu$ s
Operation		Maximum Fosc
2 Tosc	000	2.50 MHz
4 Tosc	100	5.00 MHz
8 Tosc	001	10.00 MHz
16 Tosc	101	20.00 MHz
32 Tosc	010	40.00 MHz
64 Tosc	110	48.00 MHz
RC <sup>(1)</sup>	x11	1.00 MHz <sup>(2)</sup>

**Note 1:** The RC source has a typical TAD time of 2.5  $\mu$ s.

**2:** For device frequencies above 1 MHz, the device must be in Sleep for the entire conversion or a Fosc divider should be used instead; otherwise, the A/D accuracy specification may not be met.

## 2.3 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 13 TAD per 12-bit conversion. The source of the A/D conversion clock is software selectable. There are seven possible options for TAD:

- 2 Tosc
- 4 Tosc
- 8 Tosc
- 16 Tosc
- 32 Tosc
- 64 Tosc
- Internal RC Oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be as short as possible, but greater than the minimum TAD (see parameter 130 for more information).

Table 2-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

## 2.6 A/D Conversions

Figure 2-4 shows the operation of the A/D Converter after the GO/DONE bit has been set and the ACQT2:ACQT0 bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

Figure 2-5 shows the operation of the A/D Converter after the GO/DONE bit has been set and the ACQT2:ACQT0 bits are set to '010', and selecting a 4 TAD acquisition time before the conversion starts.

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

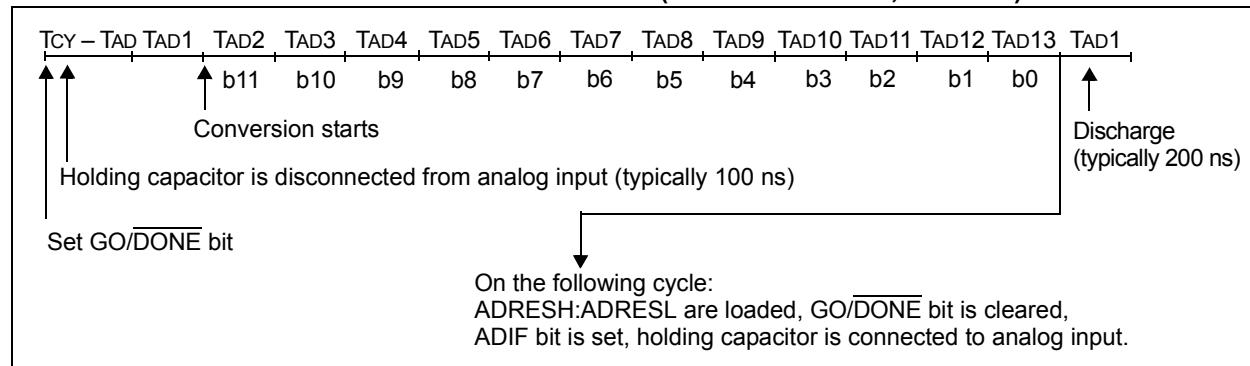
After the A/D conversion is completed or aborted, a 2 TCY wait is required before the next acquisition can be started. After this wait, acquisition on the selected channel is automatically started.

**Note:** The GO/DONE bit should **NOT** be set in the same instruction that turns on the A/D. Code should wait at least 2  $\mu$ s after enabling the A/D before beginning an acquisition and conversion cycle.

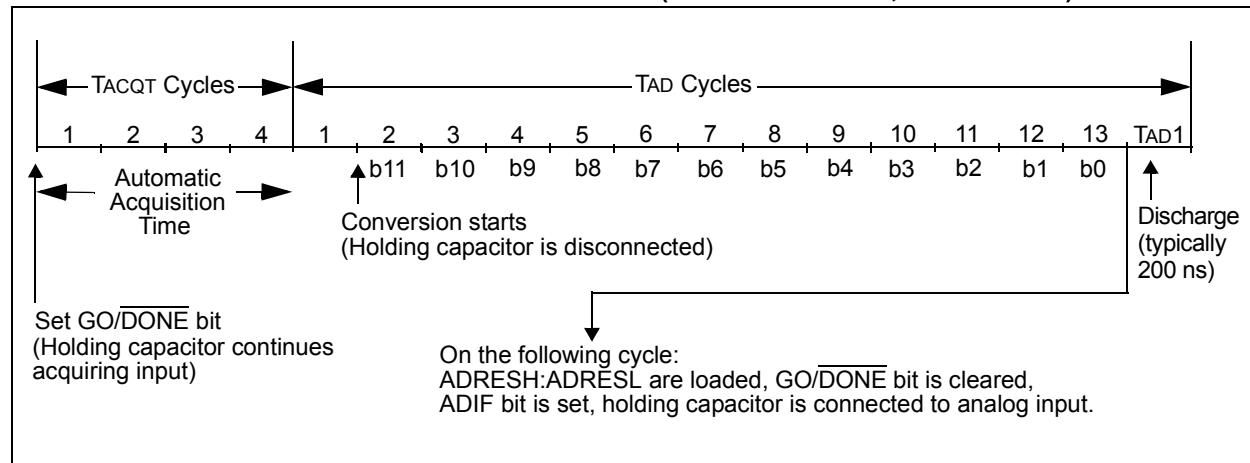
## 2.7 Discharge

The discharge phase is used to initialize the value of the holding capacitor. The array is discharged before every sample. This feature helps to optimize the unity gain amplifier, as the circuit always needs to charge the capacitor array, rather than charge/discharge based on previous measure values.

**FIGURE 2-4: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 000, TACQ = 0)**



**FIGURE 2-5: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 010, TACQ = 4 TAD)**



## 4.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings (<sup>†</sup>)

Ambient temperature under bias.....	-40°C to +125°C
Storage temperature .....	-65°C to +150°C
Voltage on any pin with respect to Vss (except VDD and <u>MCLR</u> ) .....	-0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss .....	-0.3V to +7.5V
Voltage on <u>MCLR</u> with respect to Vss ( <b>Note 2</b> ) .....	0V to +13.25V
Total power dissipation ( <b>Note 1</b> ) .....	1.0W
Maximum current out of Vss pin .....	300 mA
Maximum current into VDD pin .....	250 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>DD</sub> ).....	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>DD</sub> ) .....	±20 mA
Maximum output current sunk by any I/O pin.....	25 mA
Maximum output current sourced by any I/O pin .....	25 mA
Maximum current sunk by all ports .....	200 mA
Maximum current sourced by all ports .....	200 mA

**Note 1:** Power dissipation is calculated as follows:

$$P_{dis} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$$

**2:** Voltage spikes below V<sub>SS</sub> at the MCLR/VPP/RE3 pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR/VPP/RE3 pin, rather than pulling this pin directly to V<sub>SS</sub>.

**† NOTICE:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

# PIC18F2458/2553/4458/4553

FIGURE 4-1: PIC18F2458/2553/4458/4553 VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)

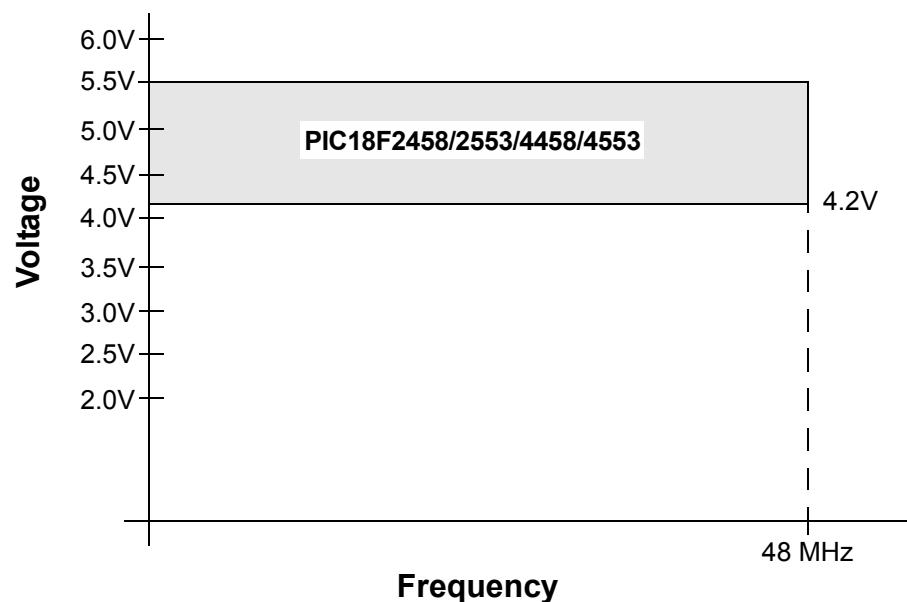
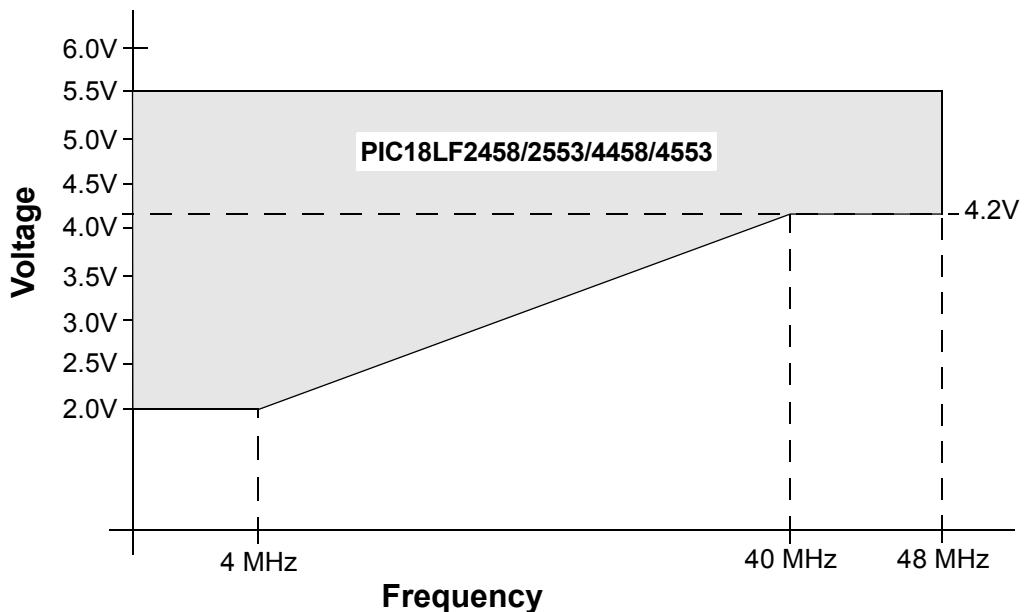


FIGURE 4-2: PIC18LF2458/2553/4458/4553 VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)



For  $2.0V \leq VDD < 4.2V$ :  $F_{MAX} = (16.36 \text{ MHz/V}) (V_{DDAPPMIN} - 2.0V) + 4 \text{ MHz}$   
For  $4.2V \leq VDD$ :  $F_{MAX} = 48 \text{ MHz}$

**Note:**  $V_{DDAPPMIN}$  is the minimum voltage of the PIC® device in the application.

# **PIC18F2458/2553/4458/4553**

---

---

**NOTES:**

# PIC18F2458/2553/4458/4553

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.		X	/XX	XXX	Examples:
Device	Temperature Range	Package	Pattern		
Device	PIC18F2458/2553 <sup>(1)</sup> , PIC18F4458/4553 <sup>(1)</sup> , PIC18F2458/2553T <sup>(2)</sup> , PIC18F4458/4553T <sup>(2)</sup> , VDD range 4.2V to 5.5V PIC18LF2458/2553 <sup>(1)</sup> , PIC18LF4458/4553 <sup>(1)</sup> , PIC18LF2458/2553T <sup>(2)</sup> , PIC18LF4458/4553T <sup>(2)</sup> , VDD range 2.0V to 5.5V				a) PIC18LF4553-I/P 301 = Industrial temp., PDIP package, Extended VDD limits, QTP pattern #301. b) PIC18LF2458-I/SO = Industrial temp., SOIC package, Extended VDD limits. c) PIC18F4458-I/P = Industrial temp., PDIP package, normal VDD limits.
Temperature Range	I = -40°C to +85°C (Industrial) E = -40°C to +125°C (Extended)				
Package	PT = TQFP (Thin Quad Flatpack) SO = SOIC SP = Skinny PDIP P = PDIP ML = QFN				<b>Note 1:</b> F = Standard Voltage Range <b>2:</b> LF = Wide Voltage Range T = In tape and reel TQFP packages only.
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise)				



# MICROCHIP

## WORLDWIDE SALES AND SERVICE

### AMERICAS

**Corporate Office**  
2355 West Chandler Blvd.  
Chandler, AZ 85224-6199  
Tel: 480-792-7200  
Fax: 480-792-7277  
Technical Support:  
<http://support.microchip.com>  
Web Address:  
[www.microchip.com](http://www.microchip.com)

**Atlanta**

Duluth, GA  
Tel: 678-957-9614  
Fax: 678-957-1455

**Boston**

Westborough, MA  
Tel: 774-760-0087  
Fax: 774-760-0088

**Chicago**

Itasca, IL  
Tel: 630-285-0071  
Fax: 630-285-0075

**Cleveland**

Independence, OH  
Tel: 216-447-0464  
Fax: 216-447-0643

**Dallas**

Addison, TX  
Tel: 972-818-7423  
Fax: 972-818-2924

**Detroit**

Farmington Hills, MI  
Tel: 248-538-2250  
Fax: 248-538-2260

**Kokomo**

Kokomo, IN  
Tel: 765-864-8360  
Fax: 765-864-8387

**Los Angeles**

Mission Viejo, CA  
Tel: 949-462-9523  
Fax: 949-462-9608

**Santa Clara**

Santa Clara, CA  
Tel: 408-961-6444  
Fax: 408-961-6445

**Toronto**

Mississauga, Ontario,  
Canada  
Tel: 905-673-0699  
Fax: 905-673-6509

### ASIA/PACIFIC

**Asia Pacific Office**  
Suites 3707-14, 37th Floor  
Tower 6, The Gateway  
Harbour City, Kowloon  
Hong Kong  
Tel: 852-2401-1200  
Fax: 852-2401-3431

**Australia - Sydney**  
Tel: 61-2-9868-6733  
Fax: 61-2-9868-6755

**China - Beijing**  
Tel: 86-10-8528-2100  
Fax: 86-10-8528-2104

**China - Chengdu**  
Tel: 86-28-8665-5511  
Fax: 86-28-8665-7889

**China - Hong Kong SAR**  
Tel: 852-2401-1200  
Fax: 852-2401-3431

**China - Nanjing**  
Tel: 86-25-8473-2460  
Fax: 86-25-8473-2470

**China - Qingdao**  
Tel: 86-532-8502-7355  
Fax: 86-532-8502-7205

**China - Shanghai**  
Tel: 86-21-5407-5533  
Fax: 86-21-5407-5066

**China - Shenyang**  
Tel: 86-24-2334-2829  
Fax: 86-24-2334-2393

**China - Shenzhen**  
Tel: 86-755-8203-2660  
Fax: 86-755-8203-1760

**China - Wuhan**  
Tel: 86-27-5980-5300  
Fax: 86-27-5980-5118

**China - Xiamen**  
Tel: 86-592-2388138  
Fax: 86-592-2388130

**China - Xian**  
Tel: 86-29-8833-7252  
Fax: 86-29-8833-7256

**China - Zhuhai**  
Tel: 86-756-3210040  
Fax: 86-756-3210049

### ASIA/PACIFIC

**India - Bangalore**  
Tel: 91-80-3090-4444  
Fax: 91-80-3090-4080

**India - New Delhi**  
Tel: 91-11-4160-8631  
Fax: 91-11-4160-8632

**India - Pune**  
Tel: 91-20-2566-1512  
Fax: 91-20-2566-1513

**Japan - Yokohama**  
Tel: 81-45-471-6166  
Fax: 81-45-471-6122

**Korea - Daegu**  
Tel: 82-53-744-4301  
Fax: 82-53-744-4302

**Korea - Seoul**  
Tel: 82-2-554-7200  
Fax: 82-2-558-5932 or  
82-2-558-5934

**Malaysia - Kuala Lumpur**  
Tel: 60-3-6201-9857  
Fax: 60-3-6201-9859

**Malaysia - Penang**  
Tel: 60-4-227-8870  
Fax: 60-4-227-4068

**Philippines - Manila**  
Tel: 63-2-634-9065  
Fax: 63-2-634-9069

**Singapore**  
Tel: 65-6334-8870  
Fax: 65-6334-8850

**Taiwan - Hsin Chu**  
Tel: 886-3-6578-300  
Fax: 886-3-6578-370

**Taiwan - Kaohsiung**  
Tel: 886-7-536-4818  
Fax: 886-7-536-4803

**Taiwan - Taipei**  
Tel: 886-2-2500-6610  
Fax: 886-2-2508-0102

**Thailand - Bangkok**  
Tel: 66-2-694-1351  
Fax: 66-2-694-1350

### EUROPE

**Austria - Wels**  
Tel: 43-7242-2244-39  
Fax: 43-7242-2244-393

**Denmark - Copenhagen**  
Tel: 45-4450-2828  
Fax: 45-4485-2829

**France - Paris**  
Tel: 33-1-69-53-63-20  
Fax: 33-1-69-30-90-79

**Germany - Munich**  
Tel: 49-89-627-144-0  
Fax: 49-89-627-144-44

**Italy - Milan**  
Tel: 39-0331-742611  
Fax: 39-0331-466781

**Netherlands - Drunen**  
Tel: 31-416-690399  
Fax: 31-416-690340

**Spain - Madrid**  
Tel: 34-91-708-08-90  
Fax: 34-91-708-08-91

**UK - Wokingham**  
Tel: 44-118-921-5869  
Fax: 44-118-921-5820